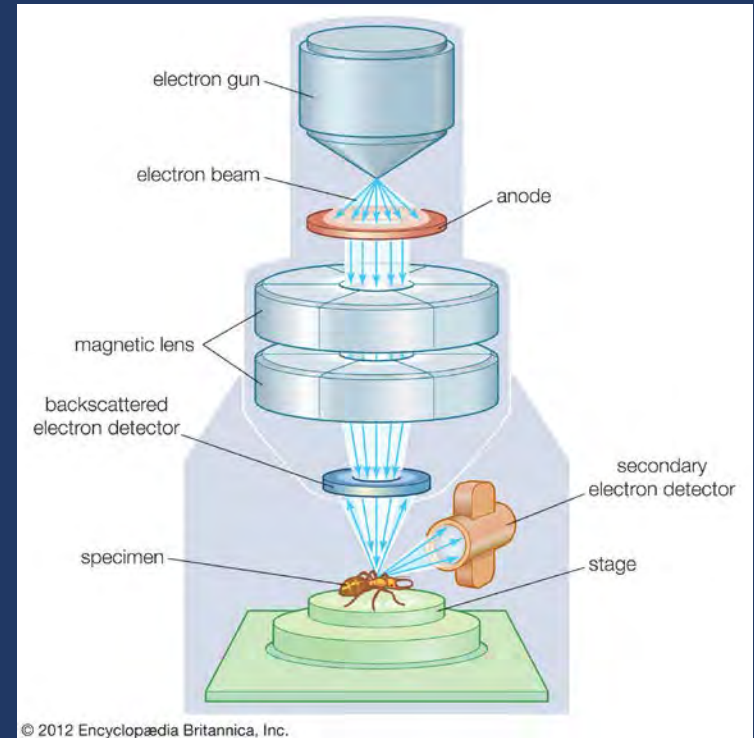
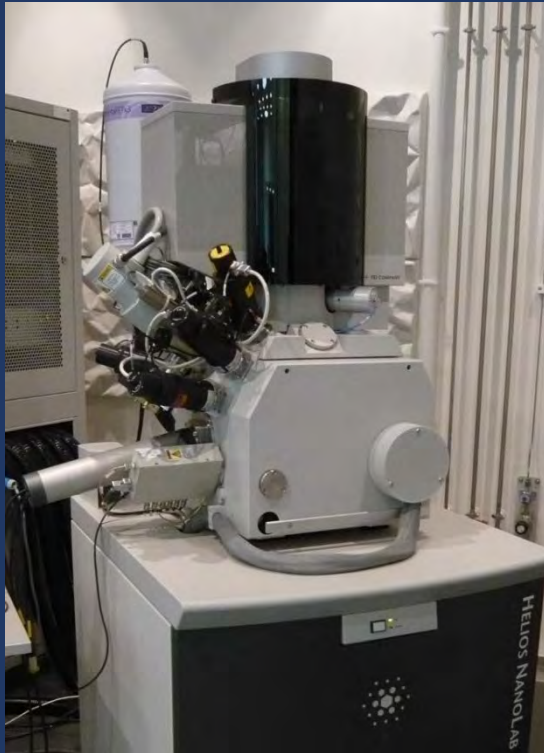


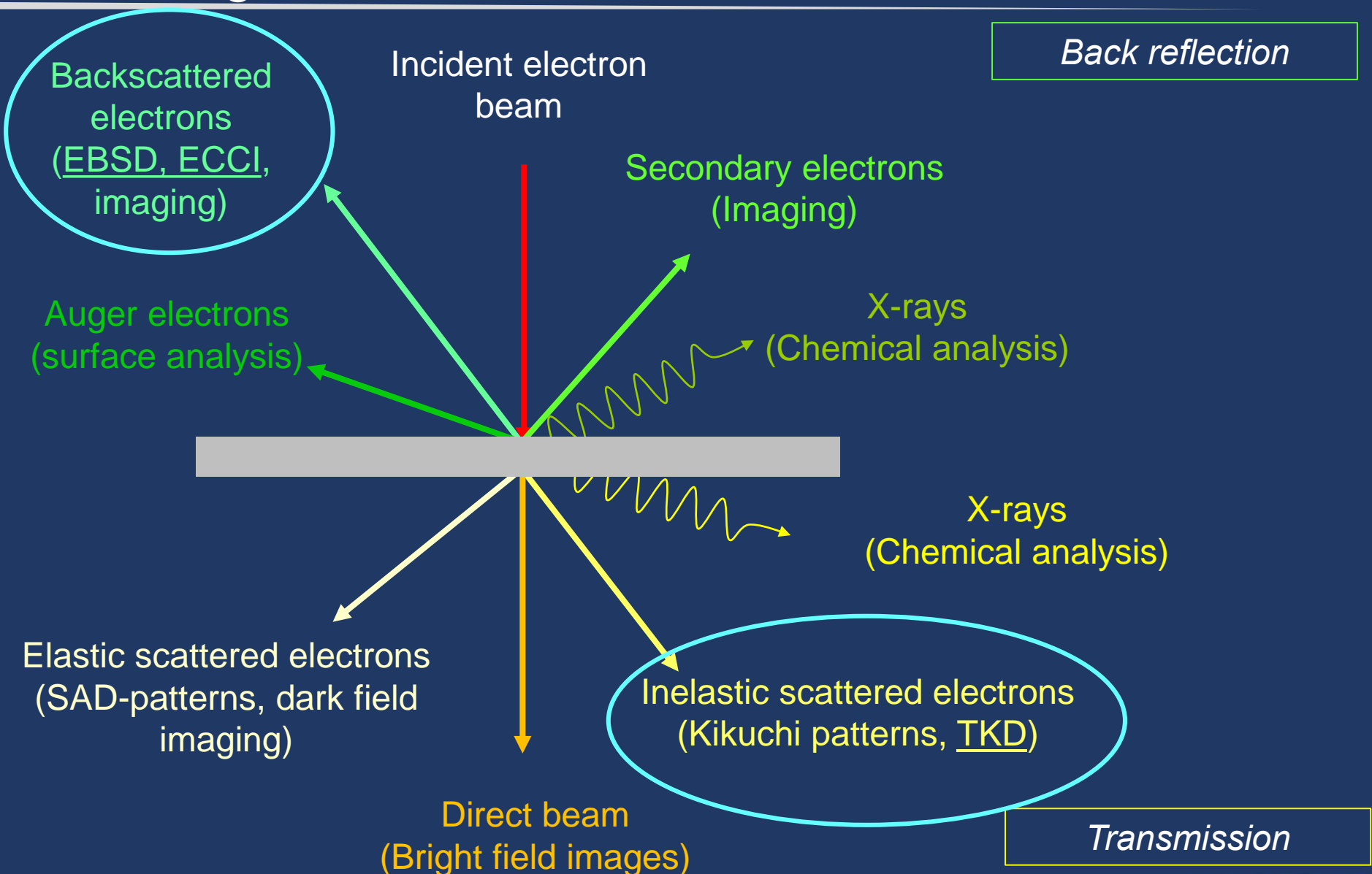
Diffraction techniques in the Scanning Electron Microscope (SEM)

Alice Bastos da Silva Fanta
DTU-Nanolab

Scanning electron microscopy (SEM)



Scattering and diffraction

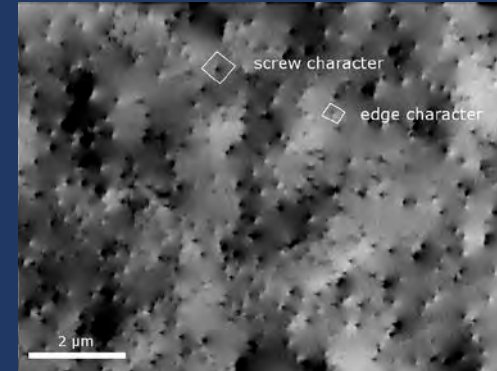


Electron Diffraction Techniques in the SEM

1. ECCI –Electron channelling contrast images

Observation of crystal defects (dislocation, stacking faults and grain boundaries)

Dislocations in nitride thin films



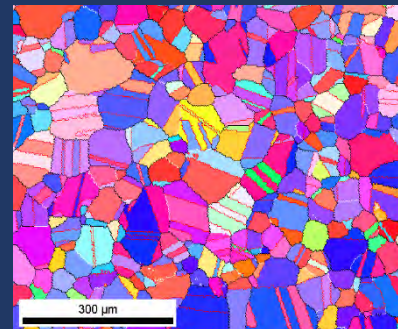
C. Trager-Cowan:

http://ssd.phys.strath.ac.uk/index.php/Electron_channeling_contrast_imaging

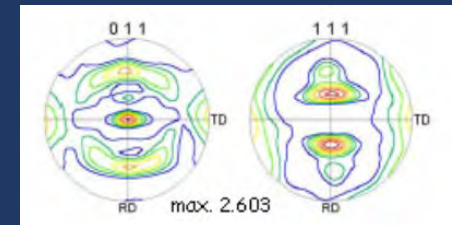
2. EBSD - Electron Backscatter Diffraction

Microstructural – crystallographic characterization technique for bulk samples

TWIP steel

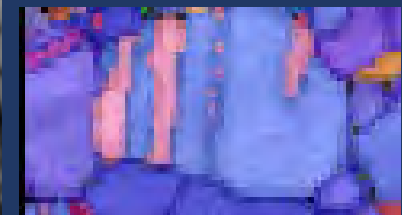


Fe3% Si



3. TKD - Transmission Kikuchi Diffraction

Microstructural – crystallographic characterization technique for thin samples



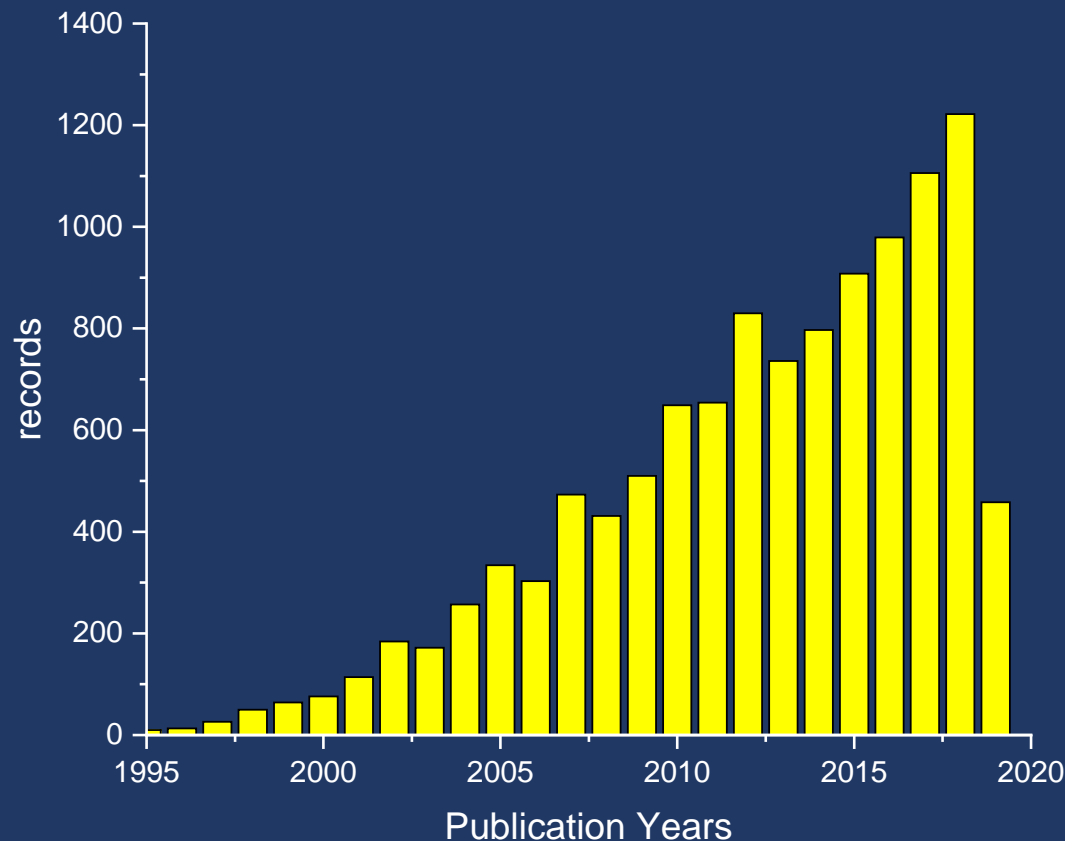
50 nm

EBSD

Electron Backscatter Diffraction

Electron backscatter diffraction - history

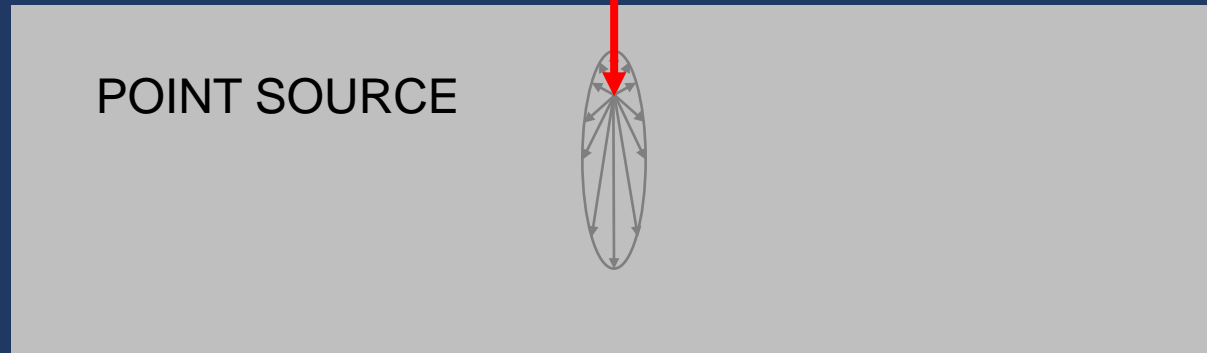
- 1928 - First observation of BKP by Nishikawa& Kikuchi
- 1973 - Observation of BKP in a SEM by Venables and Harland
- 1984 - Dingley started using TV camera and computer software for orientation determination
- 1992- Introduction of the Hough transform by Krieger Lassen et al.
- 1993 - Introduction of OIM (Orientation image microscopy) by Adams et al.



Formation of Kikuchi pattern – step 1

The formation of EBSD patterns is a two-step process

- Electrons strike the specimen



1. They are then inelastic scattered from the point source in all directions

Inelastic: some loss of energy

Formation of Kikuchi pattern – step 2

2. *crystalline materials*: those electrons (from inside the point source) are diffracted by the crystal lattice planes when the Bragg condition is satisfied

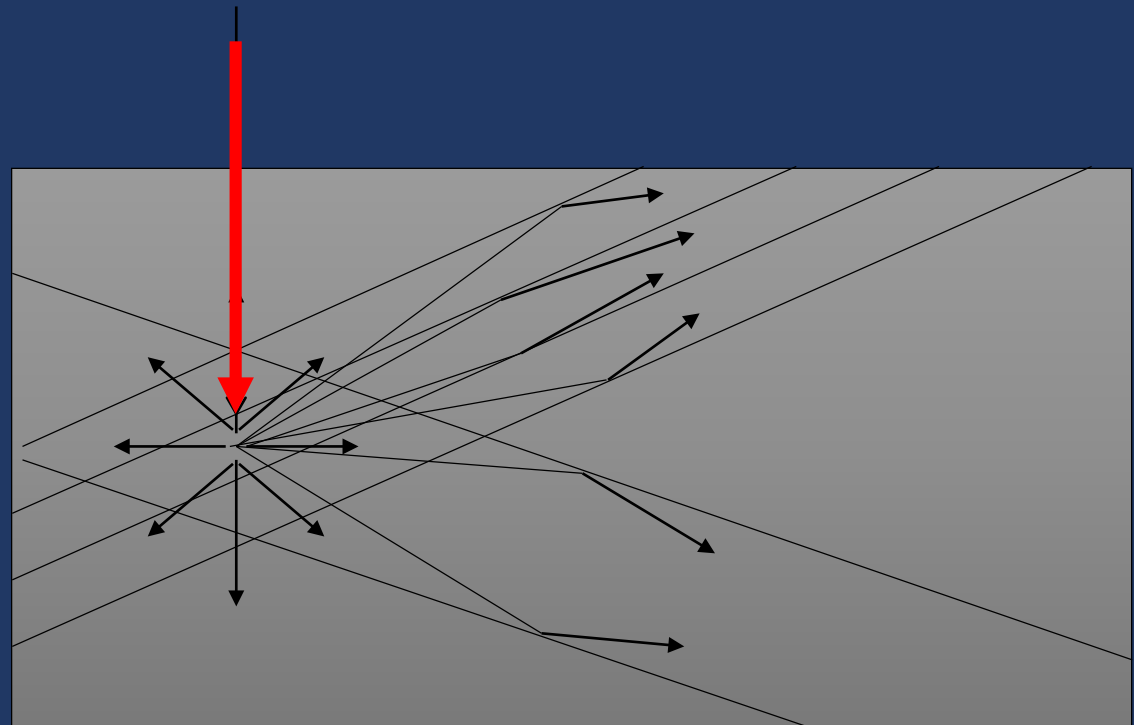
$$\text{Bragg equation: } n\lambda = 2d \sin \theta$$

λ : wavelength of the electrons

d : spacing of the crystal planes

n : is an interger

θ : angle of incidence

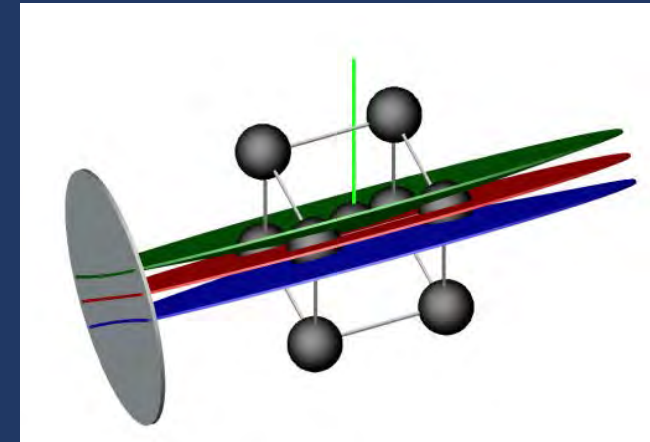
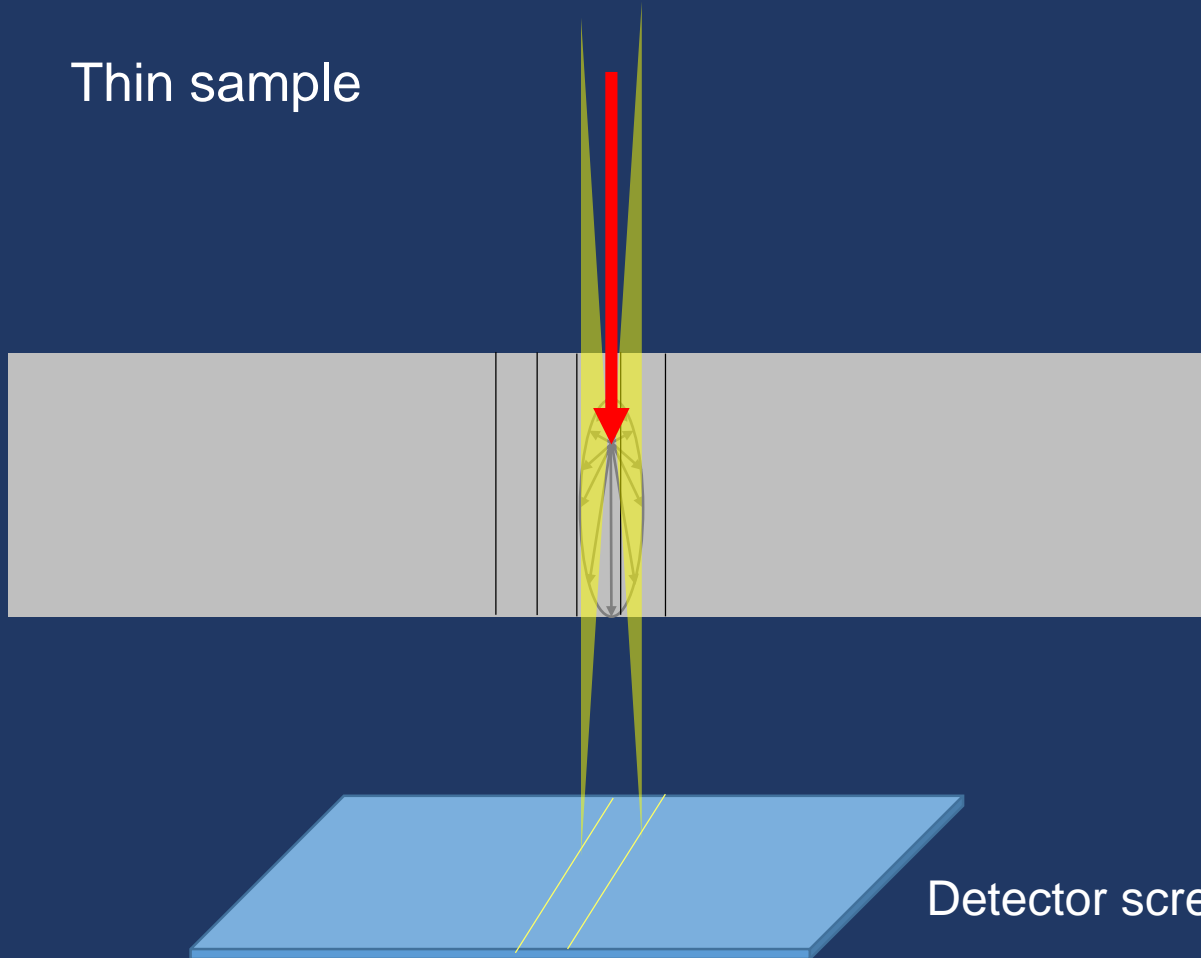


2 lattice plane

Simplified illustration – one electron and one lattice plane

- Since the scattered electrons are travelling in all direction, the diffracted beam will lie on one of two cones.

Thin sample



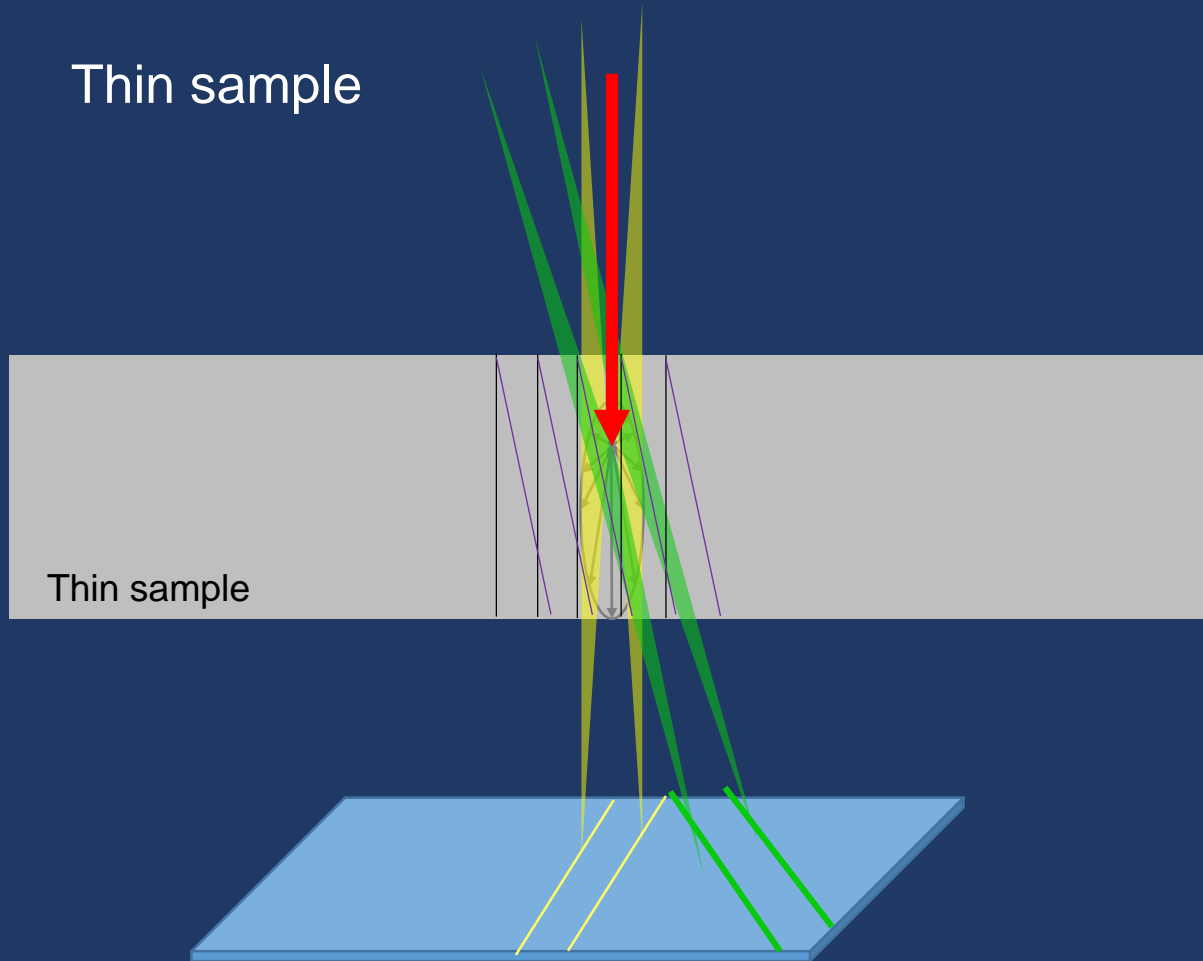
Oxford instrument

Adapted from:

Ref.: [http://ssd.phys.strath.ac.uk/index.php/Electron_backscatter_diffraction_\(EBSD\)](http://ssd.phys.strath.ac.uk/index.php/Electron_backscatter_diffraction_(EBSD))

Two electron and two lattice plane

Thin sample

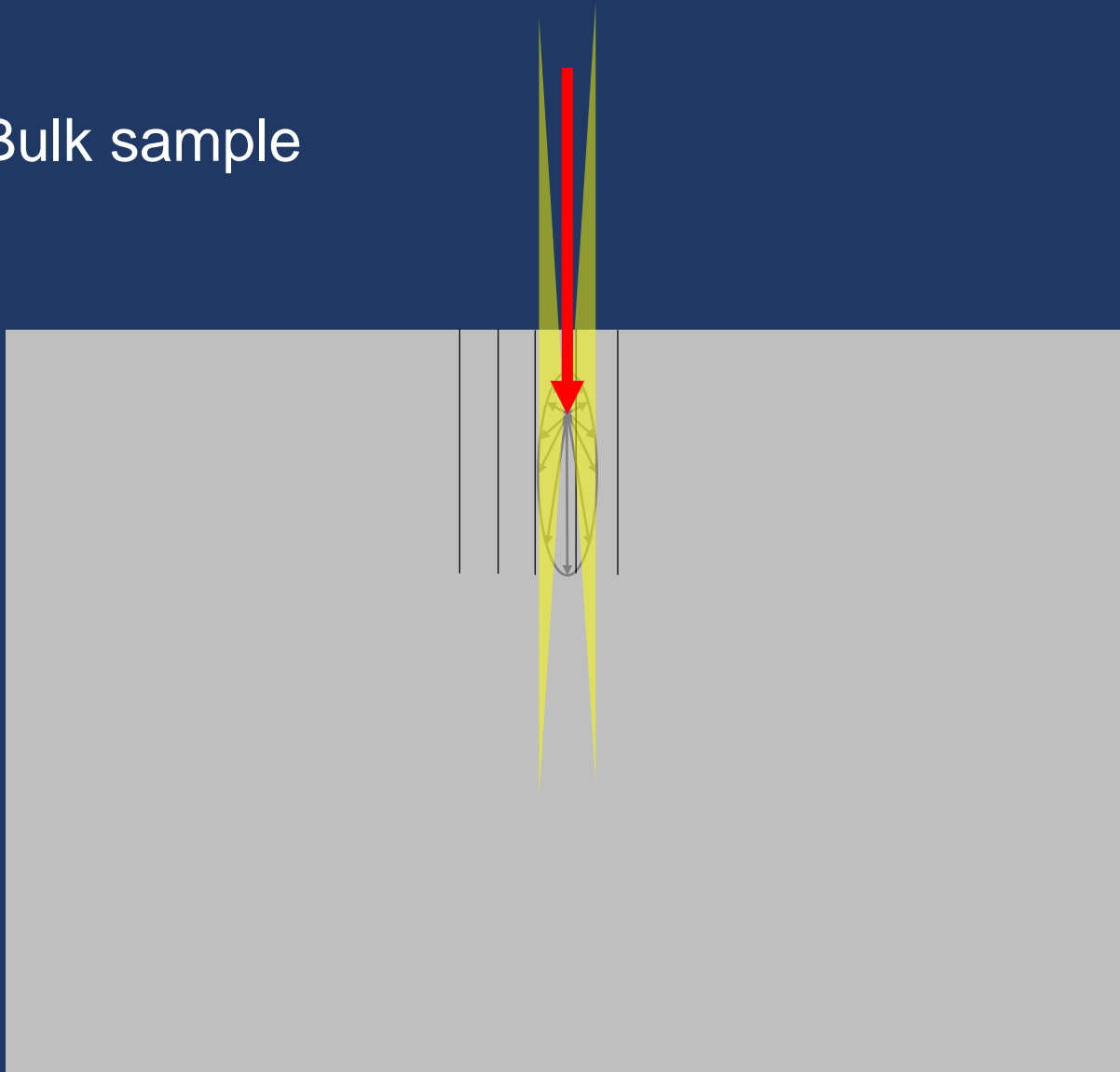


Adapted from:

Ref.: [http://ssd.phys.strath.ac.uk/index.php/Electron_backscatter_diffraction_\(EBSD\)](http://ssd.phys.strath.ac.uk/index.php/Electron_backscatter_diffraction_(EBSD))

Simplified illustration – one electron and one lattice plane

Bulk sample

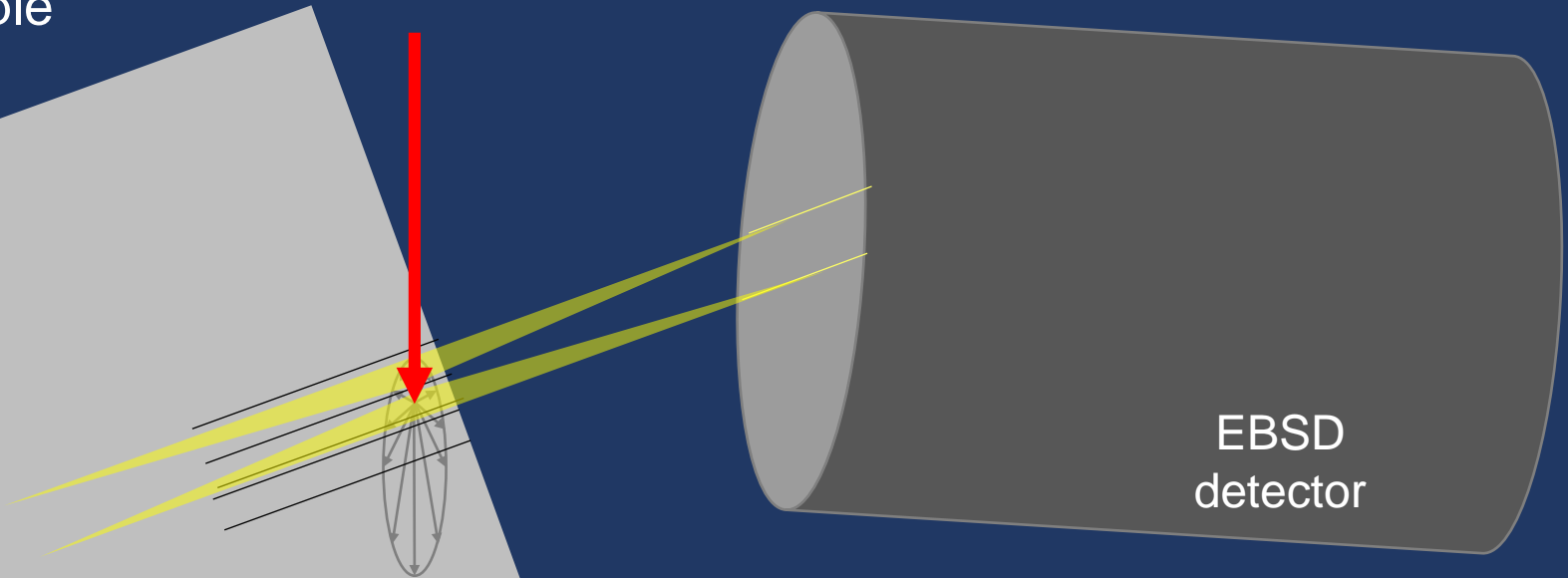


Adapted from:

Ref.: [http://ssd.phys.strath.ac.uk/index.php/Electron_backscatter_diffraction_\(EBSD\)](http://ssd.phys.strath.ac.uk/index.php/Electron_backscatter_diffraction_(EBSD))

EBSD – tilted sample

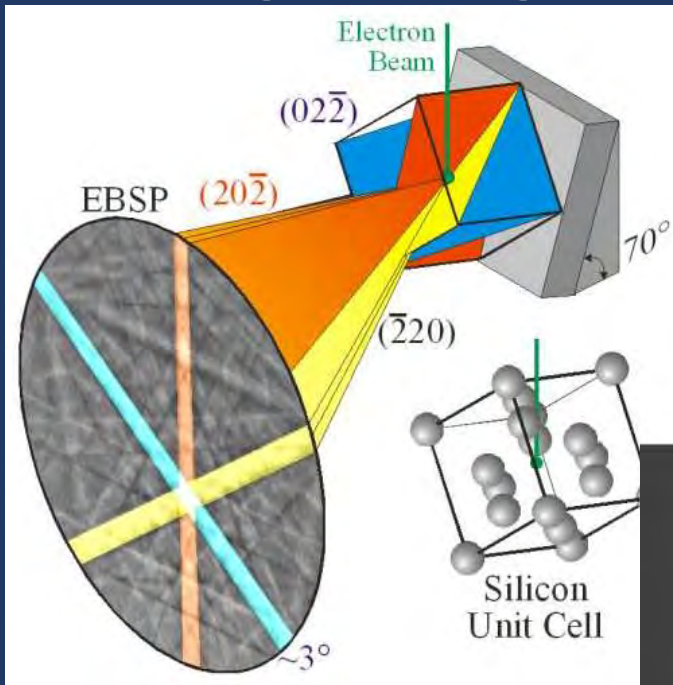
Bulk sample



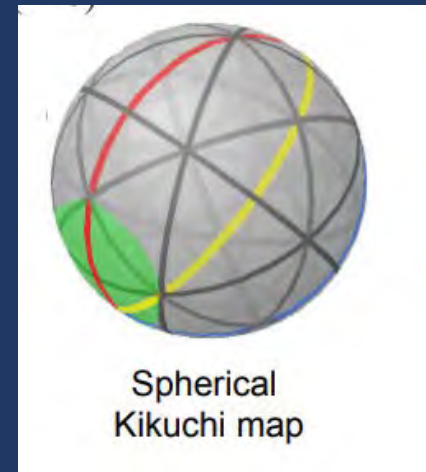
Tilt the sample to approximately
 70°
(best compromise between
intensity and resolution)

EBSD – tilted sample

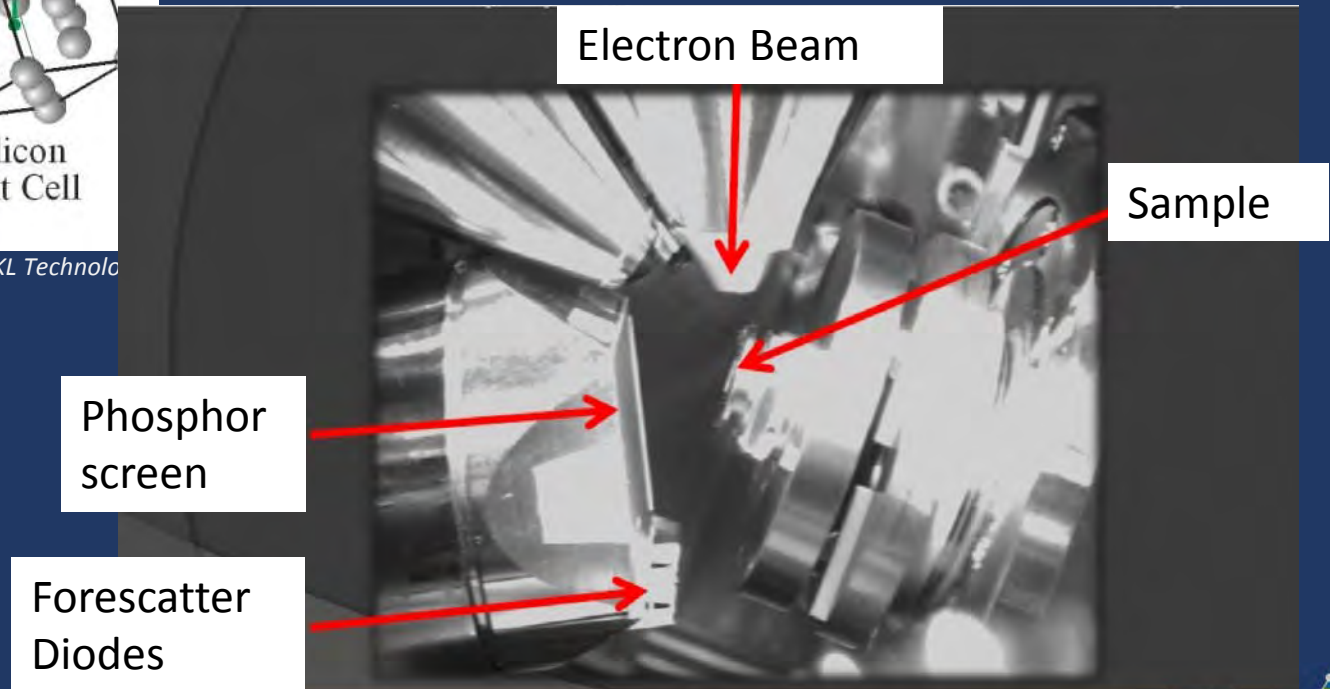
Scattering from single lattice planes



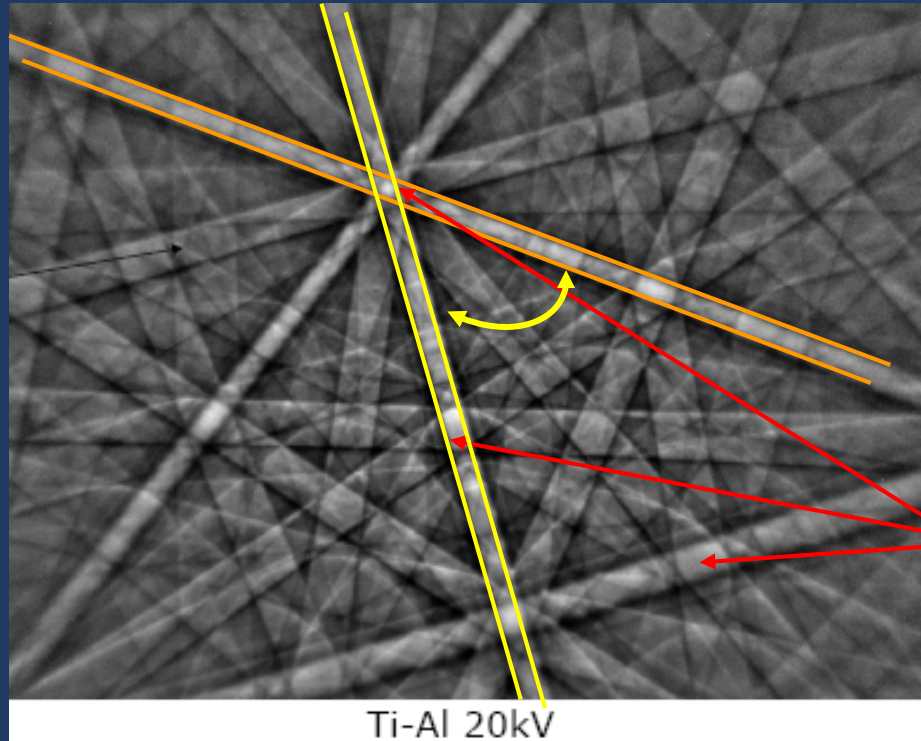
Ref.: A. P. Day et al., *Channel 5 User Manual*, HKL Technology A/S, Hobro, Denmark (2001).



View from the SEM



EBSD patterns



Ref.: Dr. Emmanuelle Boehm Courjault; Introduction to EBSD
(Electron BackScatter Diffraction) :Principle and Applications

Position of bands directly linked
to the crystallographic
orientation

Diffraction from a specific lattice plane

Intersections of bands =
intersections of planes =
zone axes

Angles between bands = angles between planes

EBSD patterns are:

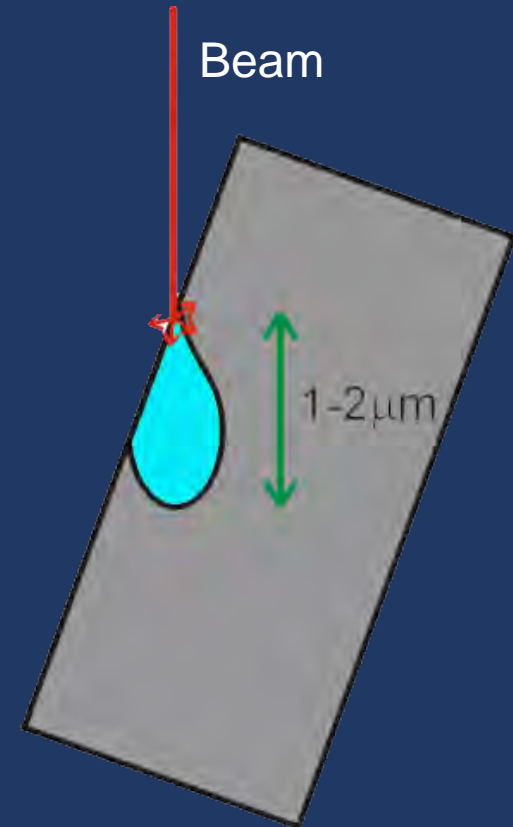
- unique for a specific crystal orientation
- is controlled by the crystal structure: space group symmetry, lattice parameters, *precise* composition

Surface sensitive technique

- Although EBSPs are created by backscattered electrons, the signal does not come from the whole BSE interaction volume
- Instead, the diffraction signal originates from a "POINT SOURCE" → 5-10nm under the surface



Surface sensitive
technique

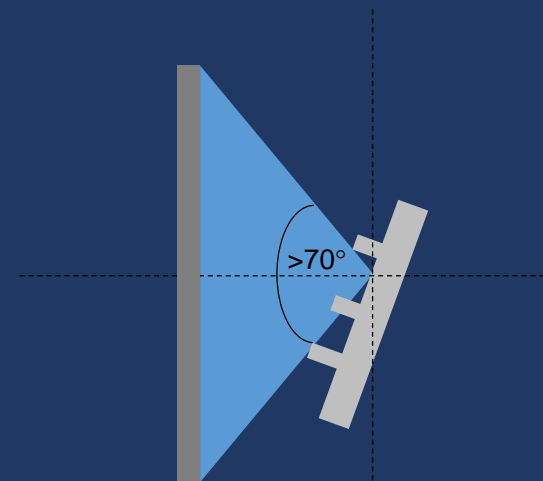
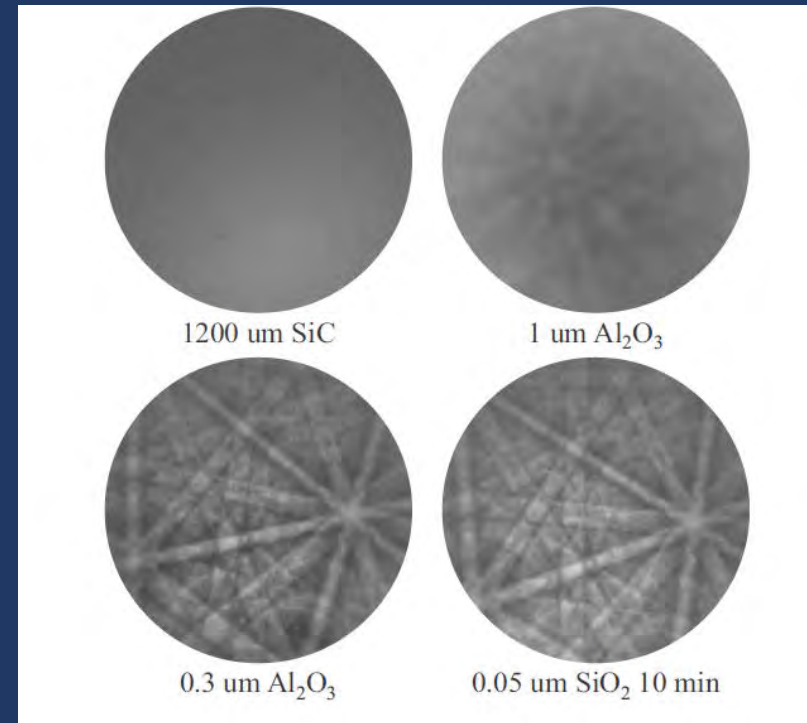


Surface sensitive technique

- The top layer
 - Free from damage
 - Free from contamination
 - or oxidation layers
 - in case of non conductive samples
→ the coat must be kept very thin – typically in the range of 2-5 nm.
- Due to high tilt angles (typically 70°),
 - surface topography must be kept to an absolute minimum.

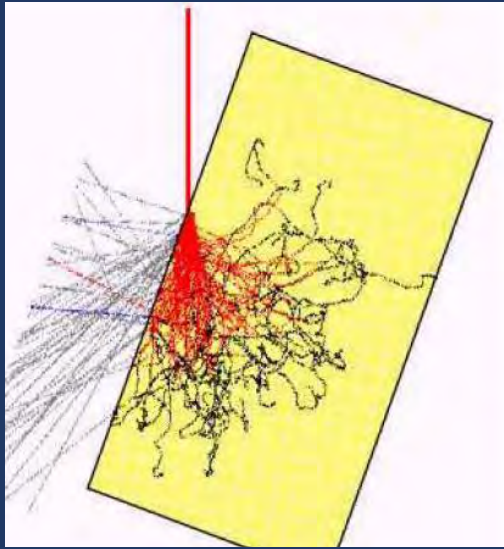


Sample strongly tilted –
Resolution y axis is 3x worst



Shadow on the screen

Signal intensity

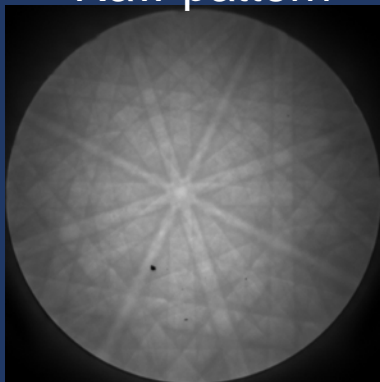


Only a small fraction of the electron arriving at the phosphor screen are diffracted

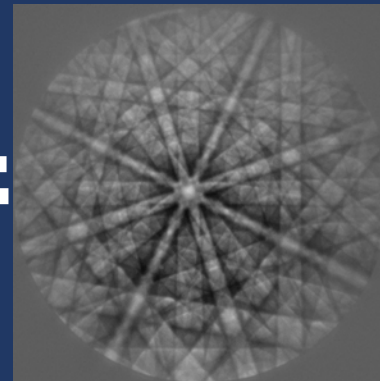
Background intensity suppresses both the contrast and sharpness.

From: S. Baeck, TSL tutorial S. Wright

Raw pattern



Background

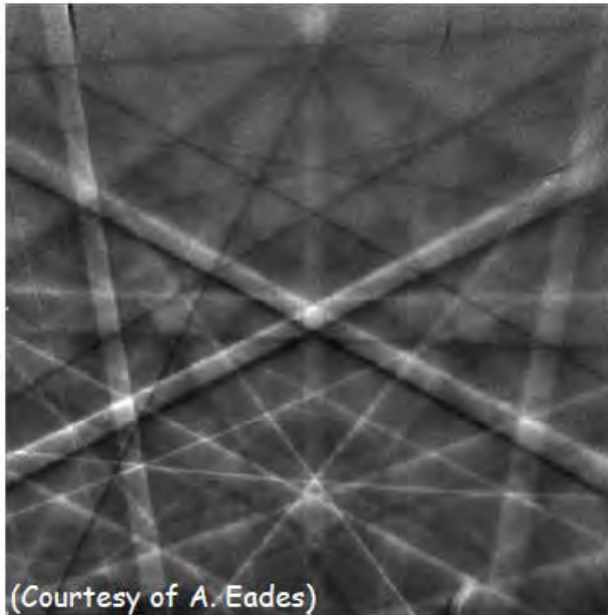


Nb-pattern from S. Zaefferer

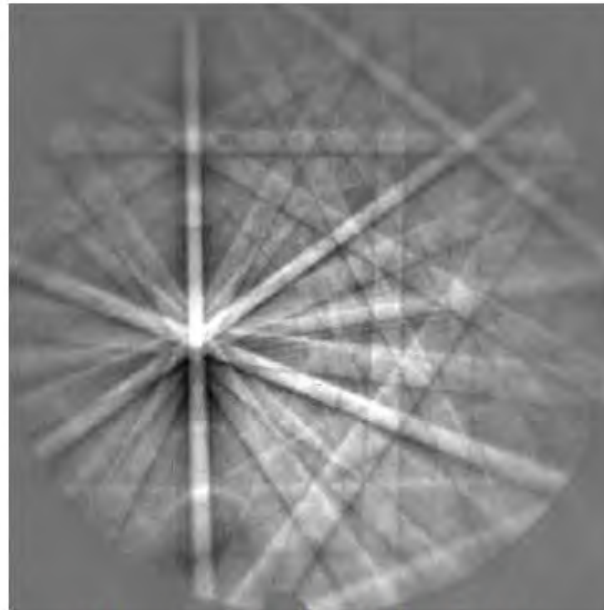
Signal is material dependent

Increasing atomic number ($\uparrow Z$):

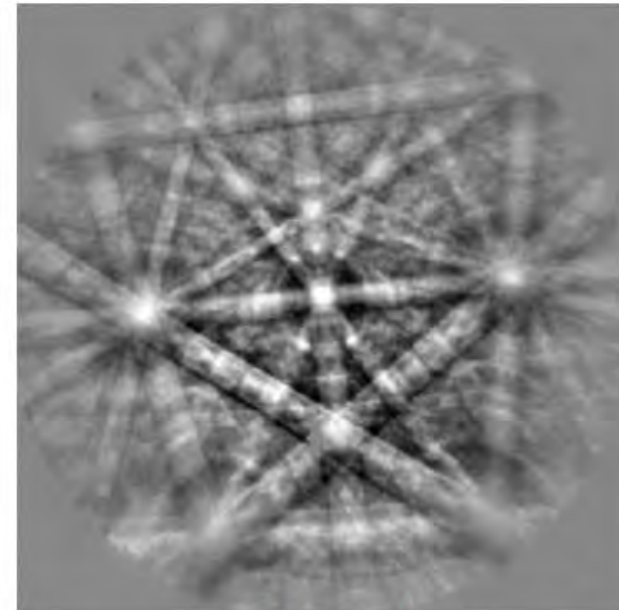
- Increase the amount of backscatter electrons – Pattern quality
- Decreases the interaction volume - improve spatial resolution



(Courtesy of A. Eades)
Beryllium ($Z=4$), 30 kV
exposure time ~ 15 s



Magnesium ($Z=12$), 15 kV
exposure time ~ 6 s



TiCr Laves phase
($Z=22\dots24$), 15 kV

Short take home message

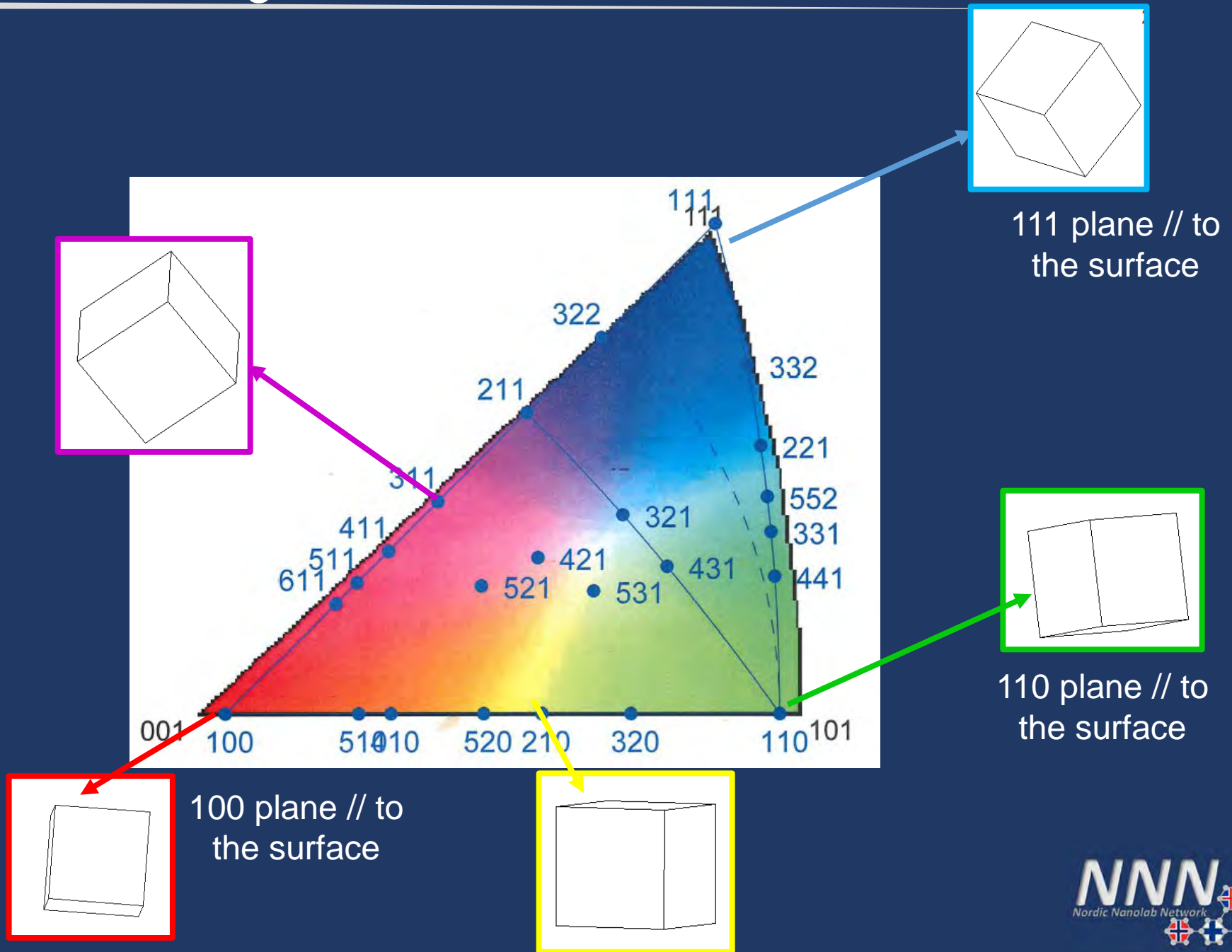
- It is not easy to prepare the sample for EBSD
- Once you get patterns, it runs fully automated

Automate data acquisition, pattern indexing and orientation determination

In one automate run you get:

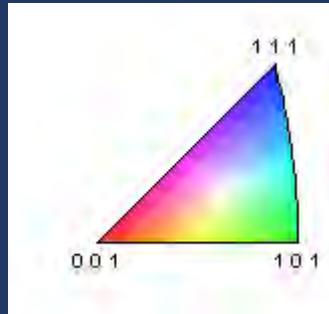
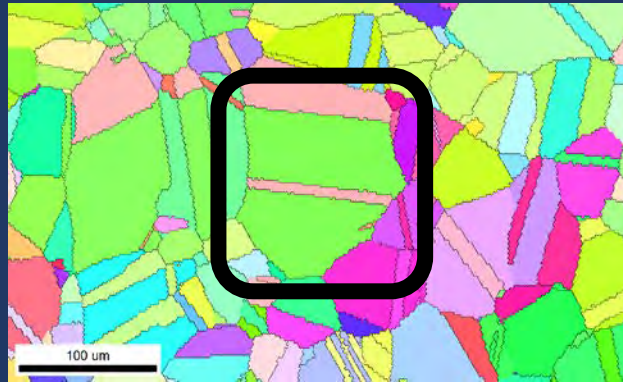
- Grain size,
- texture,
- grain boundary distribution,
- phase distribution,
- ...

Colourful image

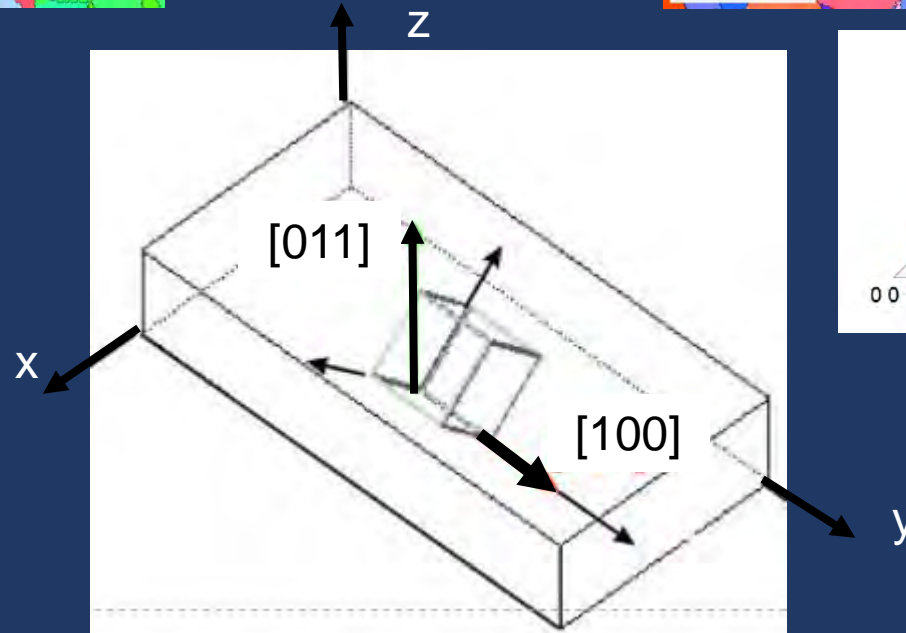
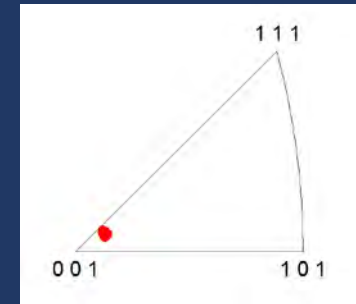
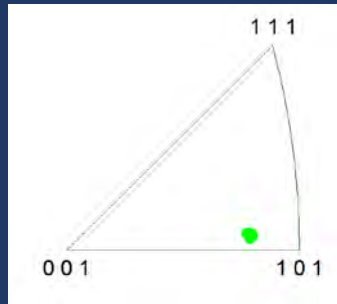
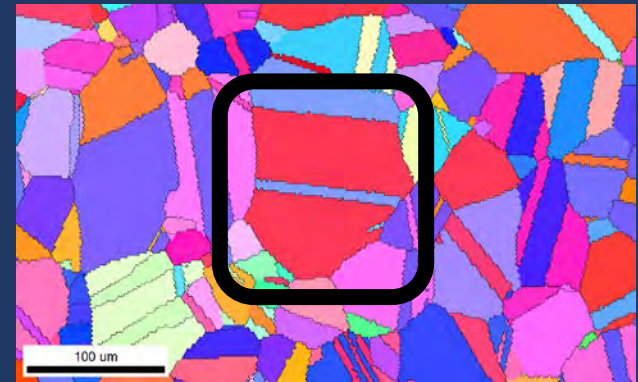


Orientation with respect to the sample coordinate system

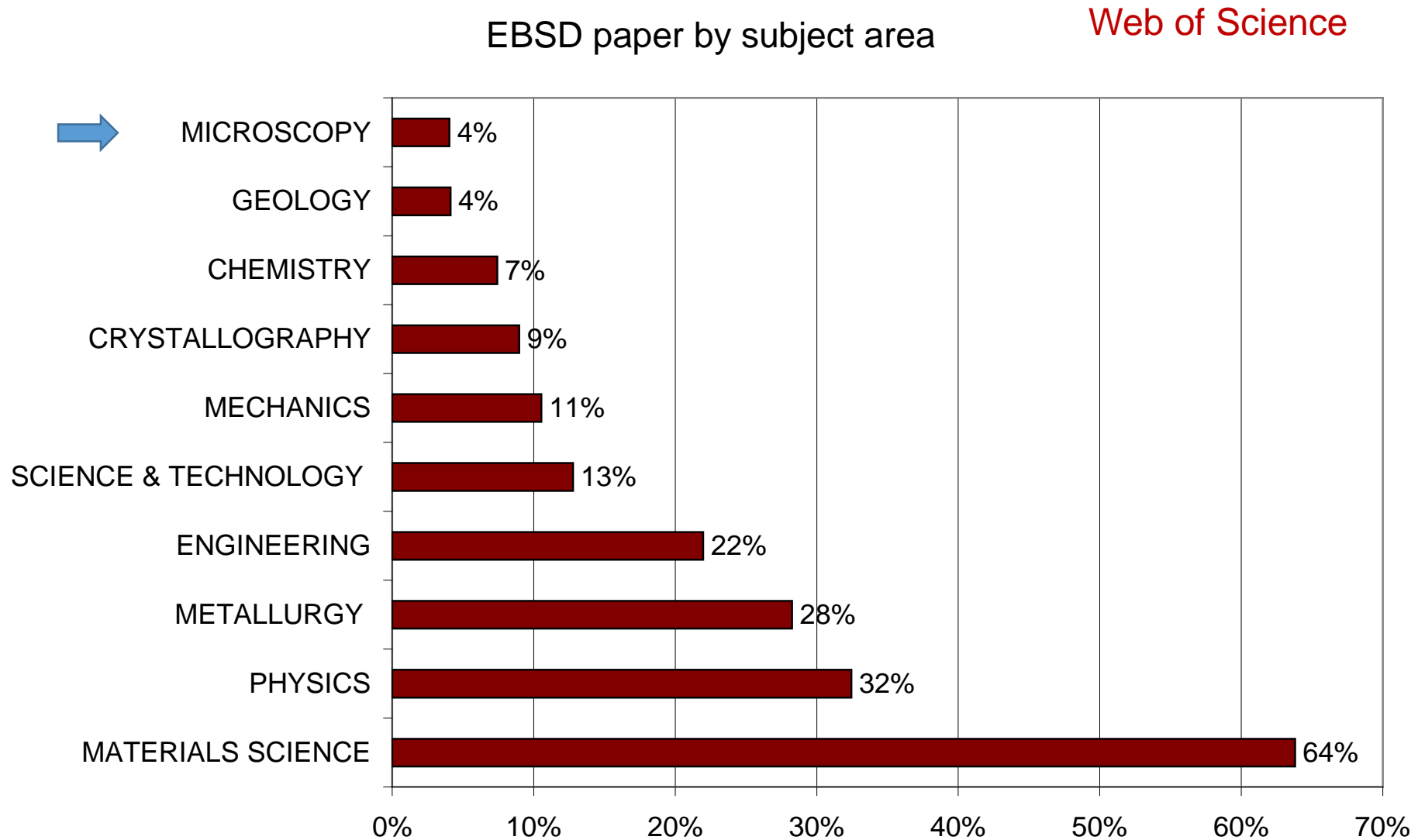
Z-direction



Y-direction

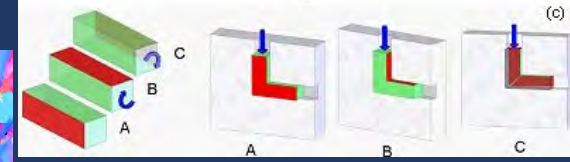
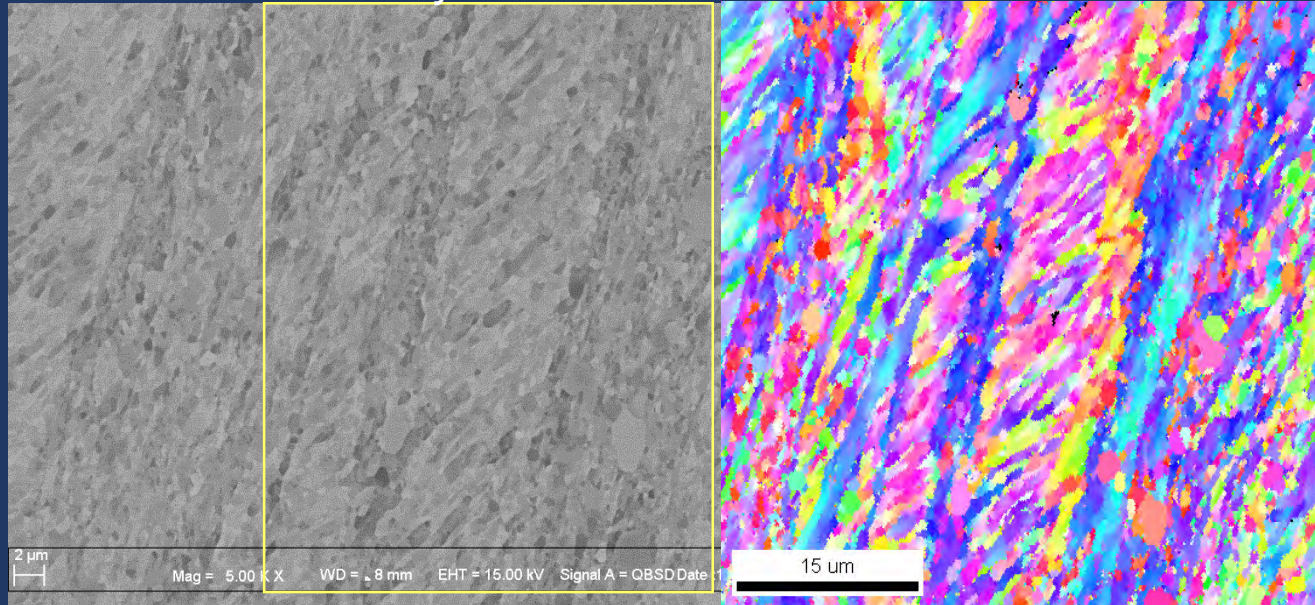


EBSD is a materials characterization tool

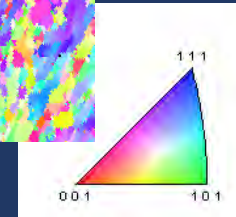


Application example -1

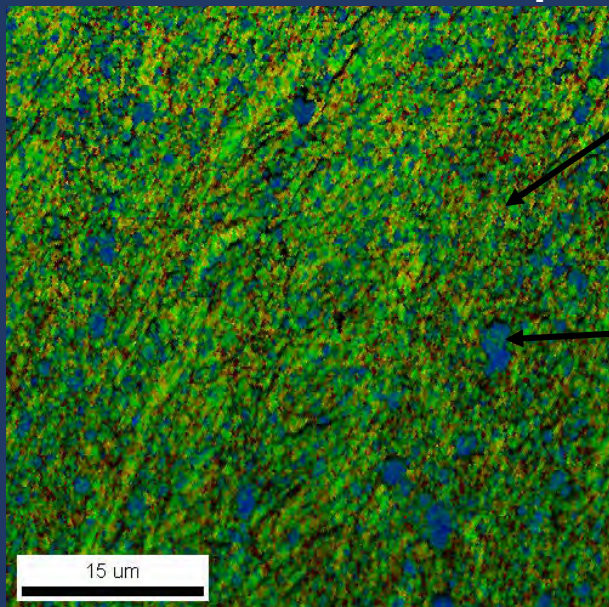
Niobium deformed by ECAP and heat treated for 15 min



Orientation bands – related to the type of deformation - **shear**

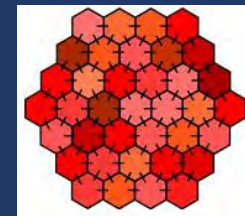


Local misorientation map



Deformed areas

Recrystallized areas



	Min	Max	Total Fraction	Partition Fraction
	0	3	0.999	0.999